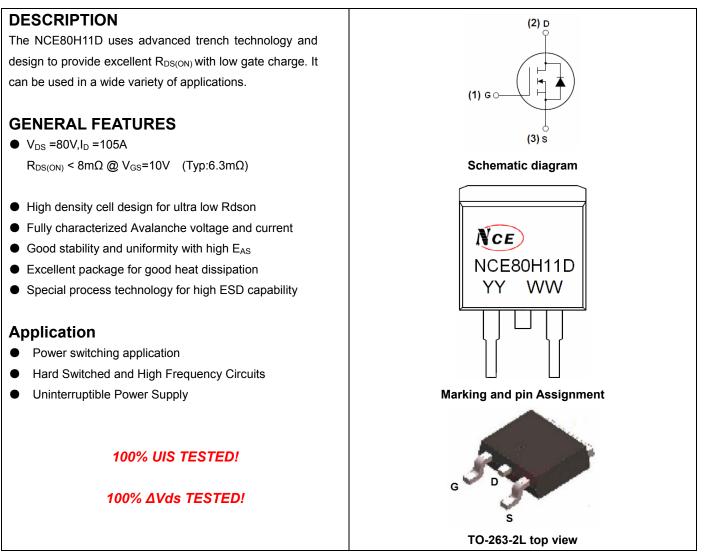


NCE80H11D

NCE N-Channel Enhancement Mode Power MOSFET



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE80H11D	NCE80H11D	TO-263-2L	-	-	-

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	80	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	105	A	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	80	А	
Pulsed Drain Current	I _{DM}	420	А	
Maximum Power Dissipation	PD	200	W	
Derating factor		1.33	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	800	mJ	



Pb Free Product

NCE80H11D

Operating Junction and Storage Temperature Range	T_{J},T_{STG}	-55 To 175	°C

Thermal Characteristic

I nermal Resistance, Junction-to-Case(Note 2) R _{BJC} 0.75 C/W

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	80	86	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)		·				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	6.3	8	mΩ
Forward Transconductance	g fs	V _{DS} =25V,I _D =40A	80	-	-	S
Dynamic Characteristics (Note4)		·				
Input Capacitance	C _{lss}		-	4900	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	410	-	PF
Reverse Transfer Capacitance	C _{rss}		-	315	-	PF
Switching Characteristics (Note 4)		·				
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	tr	VDD=30V,ID=2A,RL=15Ω,	-	19	-	nS
Turn-Off Delay Time	t _{d(off)}	RG=2.5Ω,VGS=10V	-	70	-	nS
Turn-Off Fall Time	t _f		-	30	-	nS
Total Gate Charge	Qg		-	125	-	nC
Gate-Source Charge	Q _{gs}	ID=30A,VDD=30V,VGS=10V	-	24	-	nC
Gate-Drain Charge	Q _{gd}		-	49	-	nC
Drain-Source Diode Characteristics		·				
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	105	А
Reverse Recovery Time	t _{rr}	Tj=25℃,IF=75A,	-	37		nS
Reverse Recovery Charge	Qrr	di/dt=100A/uS (Note3)	-	58		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				(LS+LD)

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ \! \mathbb{C}, V_{DD} \!=\! 40V, V_G \!=\! 10V, L \!=\! 0.5mH, Rg \!=\! 25\Omega$

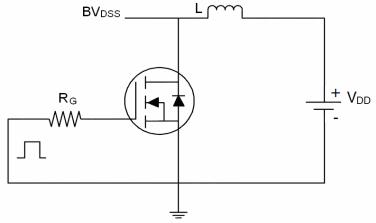


Pb Free Product

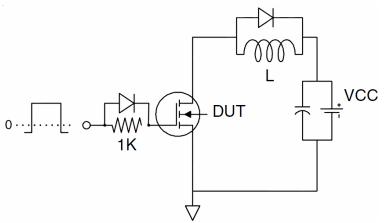


Test circuit

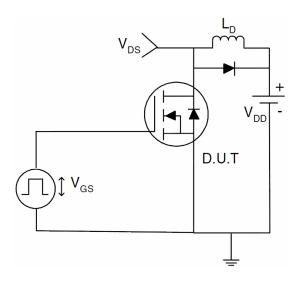
1) E_{AS} test Circuits



2) Gate charge test Circuit:



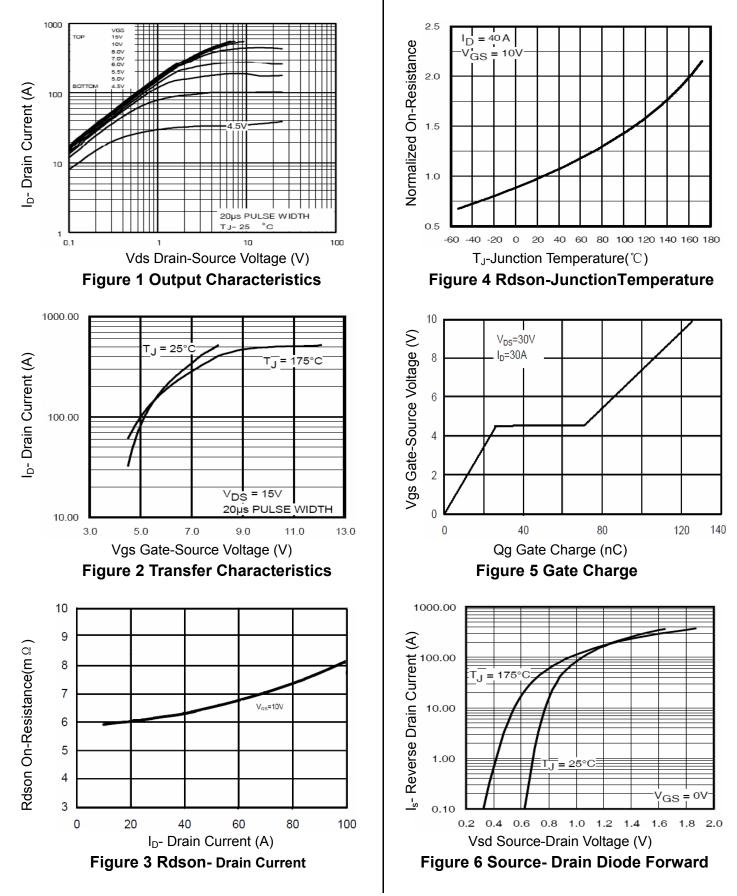
3) Switch Time Test Circuit:





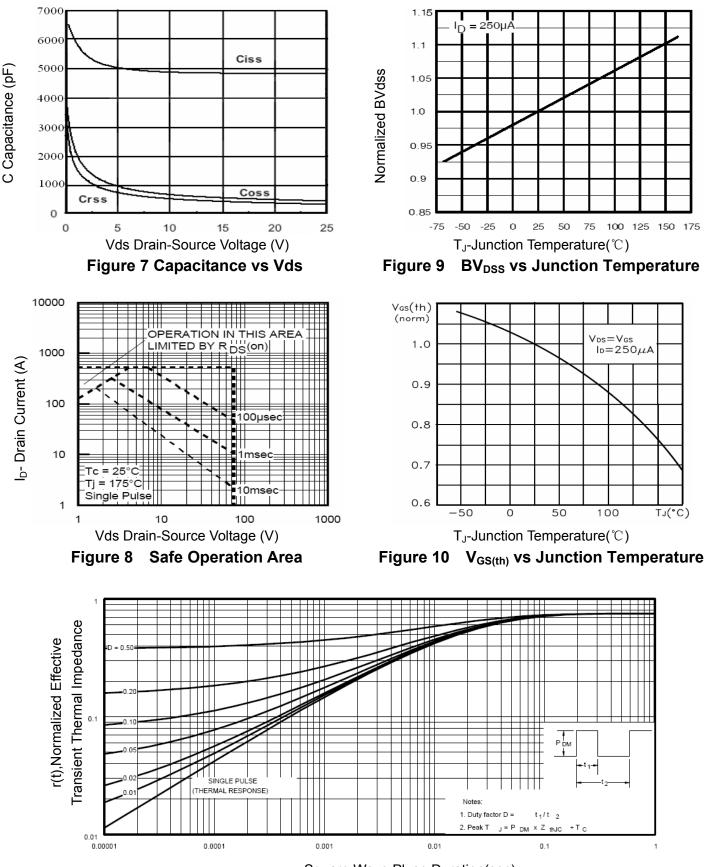
NCE80H11D

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)









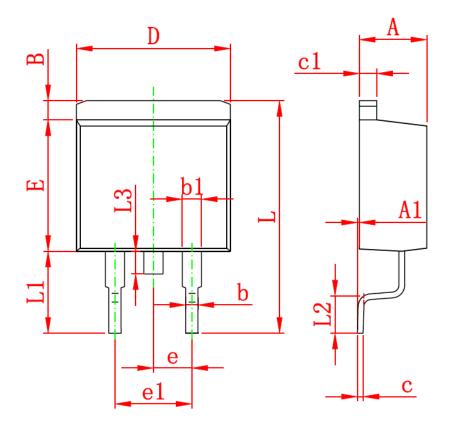
Square Wave Pluse Duration(sec)
Figure 11 Normalized Maximum Transient Thermal Impedance

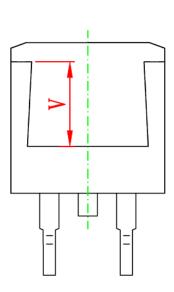




NCE80H11D

TO-263-2L PACKAGE INFORMATION





Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
Е	8.500	8.900	0.335	0.350	
e	2.540 ((TYP.)	0.100 (7	ГҮР.)	
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	REF.	0.220 REF.		





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